



August 2008

# FSA859 — Dual-Voltage, $0.8\Omega$ SPDT Analog Switch with Power-Off Isolation

#### **Features**

- Power-Off Isolation (V<sub>CC=</sub>0V)
- 0.8Ω Maximum On Resistance (R<sub>ON</sub>) for 4.5V V<sub>CC</sub>
- 0.25Ω Maximum R<sub>ON</sub> Flatness for 4.5V V<sub>CC</sub>
- Broad V<sub>CC</sub> Operating Range: 1.65V to 5.5V
- Fast Turn-On and Turn-Off Times
- Control Input Referenced to V<sub>IO</sub>
- Break-Before-Make Enable Circuitry
- 0.5mm WLCSP packaging
- ESD Performance
  - HBM: JESD22-A114, I/O to GND 8kV
  - CDM: JESD22-C101

500V

IEC61000-4-2 Contact / Air 8kV / 15kV

## Description

The FSA859 is a high-performance Single-Pole / Double-Throw (SPDT) analog switch for audio applications driven by low voltage (1.8V) baseband processors or ASICs. The device features ultra-low  $R_{ON}$  of  $0.8\Omega$  (maximum) at 4.5V  $V_{CC}$  and operates over the wide  $V_{CC}$  range of 1.65V to 5.5V. The device is fabricated with sub-micron CMOS technology to achieve fast switching speeds and is designed for break-before-make operation.

The FSA859 interfaces between the low-voltage ASIC and regular audio amplifiers and CODECs operating up to the supply range of 5.5V through the dual-voltage supplies of  $V_{\rm IO}$  and  $V_{\rm CC}$ . The  $V_{\rm IO}$  supply operates the control circuitry, allowing for 1.8V (typical) signals on the control pin (SeI).

## **Applications**

- Cellular Phone
- Portable Media Player
- PDA

#### **IMPORTANT NOTE:**

For additional performance information, please contact <a href="mailto:analogswitch@fairchildsemi.com">analogswitch@fairchildsemi.com</a>.

## **Ordering Information**

Part Number	Operating Temperature Range	Top Mark	<b>©</b> Eco Status	Package	Packing Method
FSA859UCX	-40°C to +85°C	N2	Green	8-Ball WLCSP, 0.5mm pitch	Tape and Reel

Por Fairchild's definition of "green" Eco Status, please visit: <a href="http://www.fairchildsemi.com/company/green/rohsgreen.html">http://www.fairchildsemi.com/company/green/rohsgreen.html</a>.

# **Analog Symbols**

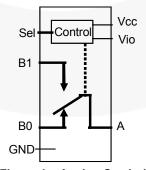
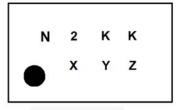


Figure 1. Analog Symbol

# **Marking Information**



KK = Lot Run Code

X = Year

Y = Work Week Z = Assembly Site

Figure 2. Top Mark with Pin 1 Orientation

# **Pin Configuration**

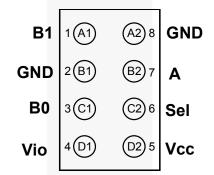


Figure 3. Pin Assignments (Top Through View)

### **Pin Definitions**

Pin	Ball	Name	Description	
1	A1	B1	Data Port (Normally Open)	
2	B1	GND	Ground	
3	C1	В0	Data Ports (Normally Closed)	
4	D1	V <sub>IO</sub>	Digital Control Supply	
5	D2	V <sub>CC</sub>	Supply Voltage	
6	C2	Sel	Control Input	
7	B2	А	Common Data Port	
8	A2	GND	Ground	

## **Truth Table**

Control Input (Sel)	Function
LOW	B0 connected to A
HIGH	B1 connected to A

## **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Min.	Max.	Unit	
V <sub>CC</sub>	Supply Voltage		-0.5	6.5	V
V <sub>IO</sub>	Digital Control Supply Voltage		-0.5	6.5	V
V <sub>sw</sub>	Switch Voltage <sup>(1)</sup>		-0.5	V <sub>CC</sub> + 0.5	V
V <sub>IN</sub>	Input Voltage <sup>(1)</sup>		-0.5	6.5	V
I <sub>IK</sub>	Input Diode Current			-50	mA
I <sub>SW</sub>	Switch Current (Continuous)			200	mA
I <sub>SWPEAK</sub>	Peak Switch Current Pulsed at 1ms Duration,		400	mA	
P <sub>D</sub>	Power Dissipation at 85°C			180	mW
T <sub>STG</sub>	Storage Temperature Range		-65	+150	°C
TJ	Maximum Junction Temperature	\ \		+150	°C
TL	Lead Temperature (Soldering, 10 seconds)			+260	°C
	Human Body Model / IEDEC: IEED22 A111)	I/O to GND: A		8	kV
	Human Body Model (JEDEC: JESD22-A114)	All Pins		2	KV
ESD	Charged Device Model (JEDEC: JESD22-C101)		500	V	
ESD	Machine Model (JEDEC: JESD22-A115)			100	V
	IEC6100-4-2 Discharge system test performed	Contact	1	8	kV
	on Fairchild's FSA859 applications testing board Air			15	K.V

#### Note:

1. The input and output negative ratings may be exceeded if the input and output diode current ratings are observed.

## **Recommended Operating Conditions**

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Min.	Max.	Unit	
V <sub>CC</sub>	Supply Voltage	1.65	5.50	V	
V <sub>IO</sub>	Digital Control Supply	1.65	1.95	V	
Sel	Control Input Voltage <sup>(2)</sup>	0	V <sub>IO</sub>	V	
$V_{SW}$	Switch Input Voltage	0	V <sub>CC</sub>	V	
T <sub>A</sub> Operating Temperature		-40	+85	°C	
$\theta_{\sf JA}$	Thermal Resistance, Still Air		350	°C/W	

#### Note:

2. Control Input must be held HIGH or LOW; it must not float.

## **Electrical Characteristics**

All typical values are at 25°C unless otherwise specified.  $V_{\text{IO}}$ =1.65 to 1.95V.

0			0		T <sub>A</sub> =+25°	С	T <sub>A</sub> =-40 to +85°C		Unit
Symbol	Parameter	V <sub>CC</sub> (V)	Conditions	Min.	Тур.	Max.	Min.	Max.	Unit
V <sub>IHIO</sub>	Input Voltage High - V <sub>IO</sub>	1.95 to 5.50					0.65•V <sub>IO</sub>	V <sub>IO</sub>	V
V <sub>ILIO</sub>	Input Voltage Low - V <sub>IO</sub>	1.95 to 5.50					0	0.35•V <sub>IO</sub>	٧
I <sub>IN</sub>	Control Input Leakage	1.95 to 5.50	V <sub>Sel</sub> =0 or V <sub>IO</sub>	-2		2	-20	20	nA
		5.50	A=1V,4.5V B0 or B1=4.5, 1V	-10		10	-50	50	
I <sub>NO(0FF)</sub> ,	Off-Leakage Current	3.60	A=1V,3.0V B0 or B1=3.0, 1V	-10		10	-50	50	
I <sub>NC(OFF)</sub> ,	of Port B0 and B1 <sup>(6)</sup>	2.70	A=0.5V,2.3V B0 or B1=2.3, 0.5V	-10		10	-50	50	nA
		1.95	A=0.3V,1.65V B0 or B1=1.65 ,0.3 V	-5		5	-20	20	
		5.50	A=float B0 or B1=4.5, 1V	-20		20	-100	100	
I <sub>NO(On),</sub>	On-Leakage Current of Port B0 and B1 <sup>(6)</sup>	3.60	A=float B0 or B1=3.0, 1V	-10		10	-20	20	
I <sub>NC(On)</sub>		2.70	A=float B0 or B1=2.3, 0.5V	-10		10	-20	20	nA
		1.95	A=float B0 or B1=1.65, 0.3V	-5		5	-20	20	
		5.50	A=1V,4.5V; B0 or B1=1V, 4.5V or floating	-20		20	-100	100	
		3.60	A=1V, 3.0VB0 or B1=1V, 3.0V or floating	-10		10	-20	20	
I <sub>A(ON)</sub>	On Leakage Current of Port A (6)	2.70	A=0.5V, 2.3V, B0 or B1=0.5V, 2.3V, or floating	-10		10	-20	20	nA
	1.95	A=0.3V, 1.65V; B0 or B1=0.3V, 1.65V, or floating	-5		5	-20	20		
l <sub>OFF</sub>	Power Off Leakage Current of Port A & Port B <sup>(6)</sup>	0	A=0 to 5.5V B0 or B1=0 to 5.5V	-1.00	0.01	1.00	-5.00	5.00	μΑ
		5.50	V <sub>IN</sub> =0 or V <sub>CC</sub> , I <sub>OUT</sub> =0		10	50		500	
ı.	Quiescent Supply	3.60	V <sub>IN</sub> =0 or V <sub>CC</sub> , I <sub>OUT</sub> =0		1.0	25.0		100.0	nΛ
I <sub>CC</sub>	Current	2.70	V <sub>IN</sub> =0 or V <sub>CC</sub> , I <sub>OUT</sub> =0		0.5	20.0		50.0	nA
		1.95	V <sub>IN</sub> =0 or V <sub>CC</sub> , I <sub>OUT</sub> =0		0.5	15.0		50.0	

Continued on the following page...

## **Electrical Characteristics** (Continued)

All typical values are at 25°C unless otherwise specified. V<sub>IO</sub>=1.65 to 1.95V.

Cumbal	Parameter	V 00	Conditions		T <sub>A</sub> =+25°(	2	T <sub>A</sub> =-40 t	o +85°C	Unit
Symbol	Parameter	V <sub>CC</sub> (V)	Conditions	Min.	Тур.	Max.	Min.	Max.	Unit
		4.50	I <sub>OUT</sub> =-100mA, B0 or B1=2.5V		0.50	0.75		0.80	
D	Switch On	3.00	I <sub>OUT</sub> =-100mA, B0 or B1=2.0V		0.75	0.90		1.2	
Ron	Resistance <sup>(3,6)</sup>	2.25	I <sub>OUT</sub> =-100mA, B0 or B1=1.8V		1.0	1.3		1.6	Ω
		1.65	I <sub>OUT</sub> =-100mA, B0 or B1=1.2V		2.5	5.0		7.0	
		4.50	I <sub>OUT</sub> =-100mA, B0 or B1=2.5V		0.05	0.10		0.10	
ΔR <sub>ON</sub>	On Resistance Matching	3.00	I <sub>OUT</sub> =-100mA, B0 or B1=2.0V		0.10	0.15		0.15	Ω
ΔKON	Between Channels <sup>(4,6)</sup>	2.25	I <sub>OUT</sub> =-100mA, B0 or B1=1.8V		0.15	0.20		0.20	12
		1.65	I <sub>OUT</sub> =-100mA, B0 or B1=1.2V		0.15	0.40		0.40	
		4.50	I <sub>OUT</sub> =-100mA, B0 or B1=1.0V, 1.5V, 2.5V		0.075	0.250		0.250	
P	On Resistance	3.00	I <sub>OUT</sub> =-100mA, B0 or B1=0.8V, 2.0V		0.1	0.3		0.3	Ω
R <sub>FLAT(ON)</sub>	Flatness <sup>(5,6)</sup>	2.25	I <sub>OUT</sub> =-100mA, B0 or B1=0.8V, 1.8V		0.25	0.50		0.6	72
		1.65	I <sub>OUT</sub> =-100mA, B0 or B1=0.6V, 1.2V		3.5				

#### Notes:

- 3. On resistance is determined by the voltage drop between A and B pins at the indicated current through the switch.
- $\Delta$  R<sub>ON</sub>=R<sub>ON</sub> maximum R<sub>ON</sub> minimum measured at identical V<sub>CC</sub>, temperature, and voltage. Flatness is defined as the difference between the maximum and minimum value of on resistance over the specified range of conditions.
- Guaranteed by characterization, not production tested for  $V_{CC}$ =1.65 1.95V.

## **AC Electrical Characteristics**

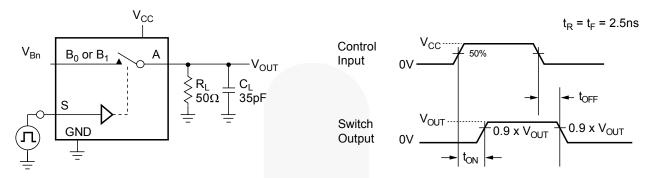
All typical value are at  $V_{IO}$ =1.8V and  $V_{CC}$ =1.8V, 2.5V, 3.0V, and 5.0V at 25°C unless otherwise specified.

		an	0		T <sub>A</sub> =+25°	С	T <sub>A</sub> =-40 t	o +85°C	l l m i f	F!
Symbol	mbol Parameter V <sub>CC</sub> (V)		Conditions	Min.	Тур.	Max.	Min.	Max.	Unit	Figure
		4.50 to 5.50		1.0	12.0	25.0	1.0	30.0		
	(6)	3.00 to 3.60	B0 or B1=V <sub>CC</sub> ,	5.0	15.0	30.0	3.0	35.0		
t <sub>ON</sub>	Turn-On Time <sup>(6)</sup>	2.30 to 2.70	$R_L$ =50 $\Omega$ , $C_L$ =35pF	5.0	20.0	35.0	5.0	40.0	ns	Figure 4
		1.65 to 1.95		10.0	50.0	70.0	10.0	75.0		
		4.50 to 5.50		1.0	9.5	20.0	1.0	25.0		
		3.00 to 3.60	B0 or B1=V <sub>CC</sub> ,	1.0	9.0	20.0	1.0	25.0		
t <sub>OFF</sub>	Turn-Off Time <sup>(6)</sup>	2.30 to 2.70	$R_L$ =50 $\Omega$ , $C_L$ =35pF	2.0	10.0	20.0	2.0	25.0	ns	Figure 4
		1.65 to 1.95		2.0	28.0	40.0	2.0	50.0		
		4.50 to 5.50		1.0	10.0	12.0	0.1	14.0		
	Break-Before-	3.00 to 3.60	B0 or B1= $V_{CC}$ , $R_L$ =50 $\Omega$ , $C_L$ =35pF	1.0	14.0	16.0	1.0	17.0	- ns	Figure 5
t <sub>BBM</sub>	Make Time <sup>(6)</sup>	2.30 to 2.70		1.0	21.0	25.0	1.0	27.0		
	1	1.65 to 1.95			35.0		2.0	50.0		
	7	5.50			47					
0	Chargo Injection	3.30	C <sub>L</sub> =1.0nF,		33					Figure 7
Q	Charge Injection	2.50	$V_{GEN}=0V$ , $R_{GEN}=0\Omega$		23				pC	
		1.65			10					
OIRR	Off Isolation	1.8 to 5.0	f=1MHz, R <sub>L</sub> =50Ω		-60				dB	Figure 6
Xtalk	Crosstalk	1.8 to 5.0	f=1MHz, R <sub>L</sub> =50Ω		55				dB	Figure 6
		5.50			60					
DIA	BW -3db Bandwidth	3.30	D -500		60				N 41 1-	Fig. 175 0
DVV		2.50	R <sub>L</sub> =50Ω		55		1		MHz	Figure 9
		1.65			50					
THD	Total Harmonic	1.80	$R_L=600\Omega$ , $V_{IN}=0.5V_{PP}$ ,		.015				%	Figure 10
	DISTOLITON	5.00	f=20Hz to 20kHz		.002		1			

# Capacitance

Symbol	Symbol Parameter		Conditions	T <sub>A=</sub> +25°C			Unit
Symbol	Parameter	V <sub>cc</sub> (V)	Conditions	Min.	Тур.	Max.	Offic
C <sub>IN</sub>	Control Pin Input Capacitance	0	f=1MHz		3.2		pF
C <sub>OFF</sub>	B Port Off Capacitance	1.65 to 5.50	f=1MHz		50		pF
Con	A Port On Capacitance	1.65 to 5.50	f=1MHz		150		pF

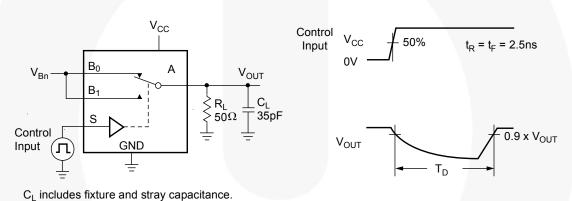
## **Test Diagrams**



C<sub>L</sub> includes fixture and stray capacitance.

Logic input waveforms inverted for switches that have the opposite logic sense.

Figure 4. Turn On / Off Timing



, ,

Figure 5. Break-Before-Make Timing

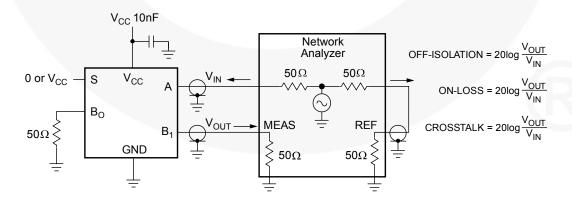


Figure 6. Off Isolation and Crosstalk

## Test Diagrams (Continued)

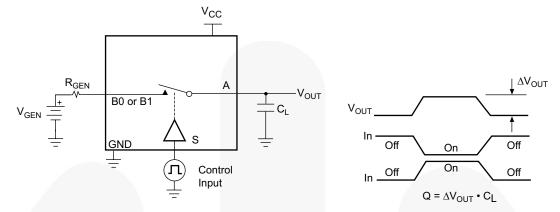


Figure 7. Charge Injection

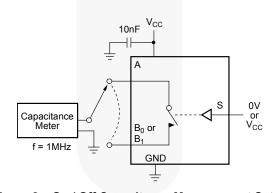


Figure 8. On / Off Capacitance Measurement Setup

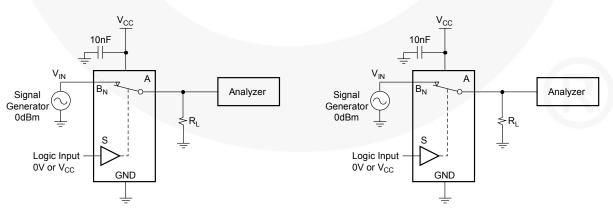
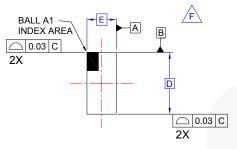


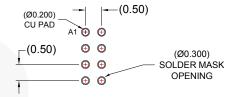
Figure 9. Bandwidth

Figure 10. Harmonic Distortion

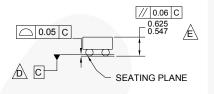
## **Physical Dimensions**



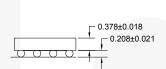
TOP VIEW

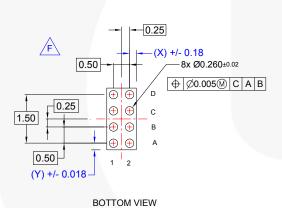


RECOMMENDED LAND PATTERN (NSMD)



SIDE VIEWS





#### NOTES:

- A. NO JEDEC REGISTRATION APPLIES.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCE PER ASMEY14.5M, 1994.
- DATUM C, THE SEATING PLANE IS DEFINED BY THE SPHERICAL CROWNS OF THE BALLS.
- E PACKAGE NOMINAL HEIGHT IS 586 MICRONS ±39 MICRONS (547-625 MICRONS).
- FOR DIMENSIONS D, E, X, AND Y SEE PRODUCT DATASHEET.
- G. BALL COMPOSITION: Sn95.5Ag3.9Cu0.6
- H. DRAWING FILNAME: MKT-UC008ADrev2

Figure 11. 8-Ball, WLCSP 0.5mm Pitch

**Table 1. Product Specific Dimensions** 

Product	D	E	X	Y
FSA859UCX	1.910	0.910	0.205	0.205

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

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Quiet Series™
RapidConfigure™
Saving our world, 1mW at a time™
SmartMax™
SMART START™
SPM®
STEALTH™
SuperFET™
SuperSOT™.3
SuperSOT™.8
SuperSOT™.8
SuperSOT™.8
SuperSOT™.8
SuperSOT™.8
SupreMOS™
SyncFET™
System ®

The Power Franchise®

TinyBoost™
TinyBoost™
TinyBuck™
TinyPower™
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- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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#### Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete Not In Production		Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. 135